

## WP4060VH/2ID

1.8 mm Bi-Level Circuit Board Indicator



### **DESCRIPTION**

• The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode

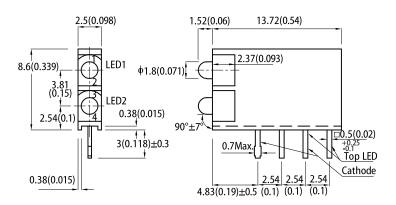
## **FEATURES**

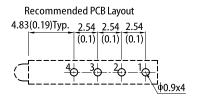
- · Pre-trimmed leads for pc mounting
- Black case enhances contrast ratio
- · Wide viewing angle
- · High reliability life measured in years
- Housing UL rating: 94V-0
- Housing material: Type 66 nylon
- RoHS compliant

#### **APPLICATIONS**

- Status indicator
- Illuminator
- · Signage applications
- · Decorative and entertainment lighting
- · Commercial and residential architectural lighting

### **PACKAGE DIMENSIONS**





- All dimensions are in millimeters (inches).
   Tolerance is ±0.25(0.01") unless otherwise noted.
- Lead spacing is measured where the leads emerge from the package.
   The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice

## **SELECTION GUIDE**

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 10mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
WP4060VH/2ID	■ High Efficiency Red (GaAsP/GaP)	Red Diffused	8	15	700
			*4	*8	70°

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

\* Luminous intensity value is traceable to CIE127-2007 standards.





## ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Farameter	Symbol	Emitting Color	Тур.	Max.	Onit
Wavelength at Peak Emission I <sub>F</sub> = 10mA	$\lambda_{peak}$	High Efficiency Red	627	-	nm
Dominant Wavelength I <sub>F</sub> = 10mA	λ <sub>dom</sub> <sup>[1]</sup>	High Efficiency Red	617	-	nm
Spectral Bandwidth at 50% Φ REL MAX I <sub>F</sub> = 10mA	Δλ	High Efficiency Red	45	-	nm
Capacitance	С	High Efficiency Red	15	-	pF
Forward Voltage I <sub>F</sub> = 10mA	V <sub>F</sub> <sup>[2]</sup>	High Efficiency Red	1.9	2.3	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	High Efficiency Red	-	10	uA

#### Notes:

## ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	P <sub>D</sub>	75	mW	
Reverse Voltage	V <sub>R</sub>	5	V	
Junction Temperature	T <sub>j</sub>	125	°C	
Operating Temperature	T <sub>op</sub>	-40 To +85	°C	
Storage Temperature	$T_{stg}$	-40 To +85	°C	
DC Forward Current	I <sub>F</sub>	30	mA	
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	160	mA	
Electrostatic Discharge Threshold (HBM)	-	8000	V	
Lead Solder Temperature [2]		260°C For 3 Seconds		
Lead Solder Temperature [3]		260°C For 5 Seconds		

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.
4. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



Notes:

1. The dominant wavelength (\(\lambda\dot)\) above is the setup value of the sorting machine. (Tolerance \(\lambda\dot\): \(\pm 1 n m.\))

2. Forward voltage: \(\pm 2.1 \).

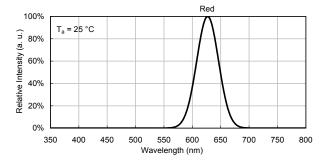
3. Wavelength value is traceable to CIE127-2007 standards.

4. Excess driving current and \(\frac{1}{2}\) or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

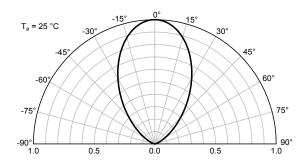


### **TECHNICAL DATA**

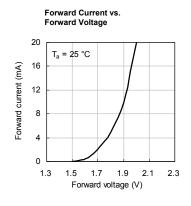
#### **RELATIVE INTENSITY vs. WAVELENGTH**

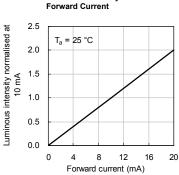


## **SPATIAL DISTRIBUTION**

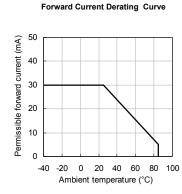


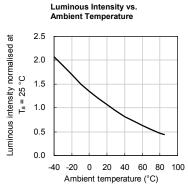
### **HIGH EFFICIENCY RED**



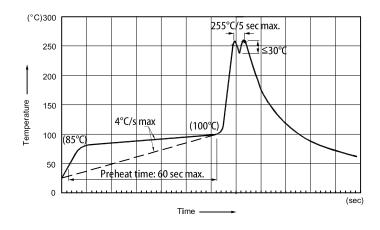


Luminous Intensity vs.



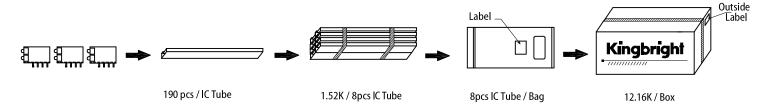


## **RECOMMENDED WAVE SOLDERING PROFILE**

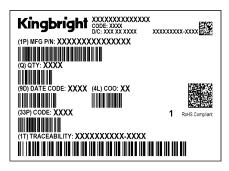


- Notes:
  1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260  $^{\circ}\mathrm{C}$
- 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
- 3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
  4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5. SAC 305 solder alloy is recommended.6. No more than one wave soldering pass.

## **PACKING & LABEL SPECIFICATIONS**







#### **PRECAUTIONS**

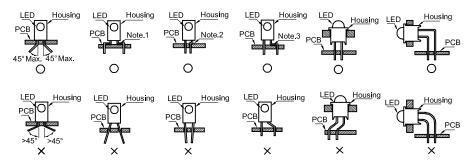
### **Storage Conditions**

- 1. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
- 2. LEDs should be stored with temperature ≤ 30°C and relative humidity < 60%.
- 3. Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.

## **LED Mounting Method**

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

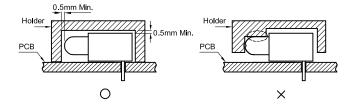
Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.



○ " Correct mounting method " x " Incorrect mounting method

## **Lead Forming Procedures**

- 1. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during
- 2. The tip of the soldering iron should never touch the lens epoxy.
- 3. Through-hole LEDs are incompatible with reflow soldering.
- 4. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.



#### PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
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